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Kind regards,

Team Nexperia

# 74LVCH16541A

16-bit buffer/line driver; 3-state

Rev. 3 — 15 February 2012

Product data sheet

## 1. General description

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The 74LVCH16541A is a 16-bit buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs ( $\overline{1OE_n}$  and  $\overline{2OE_n}$ ). A HIGH on  $\overline{nOE_n}$  causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

## 2. Features and benefits

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- 5 Volt tolerant inputs and outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance outputs when  $V_{CC} = 0$  V
- All data inputs have bus hold
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from  $-40$  °C to  $+85$  °C and  $-40$  °C to  $+125$  °C.



## 3. Ordering information

Table 1. Ordering information

| Type number     | Package           |         |  | Version  |
|-----------------|-------------------|---------|--|----------|
|                 | Temperature range | Name    | Description  |          |
| 74LVCH16541ADGG | -40 to +125 °C    | TSSOP48 | plastic thin shrink small outline package; 48 leads; body width 6.1 mm | SOT362-1 |
| 74LVCH16541ADL  | -40 to +125 °C    | SSOP48  | plastic shrink small outline package; 48 leads; body width 7.5 mm      | SOT370-1 |

## 4. Functional diagram

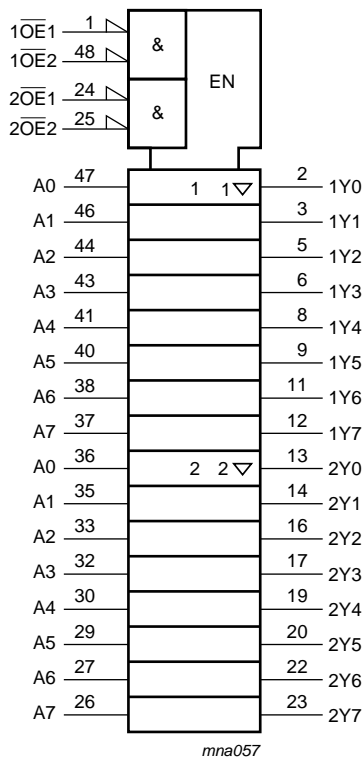


Fig 1. IEC logic symbol

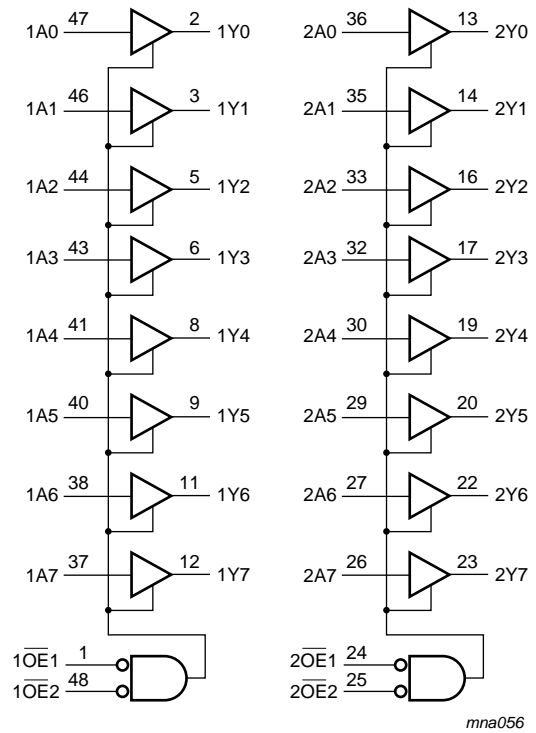


Fig 2. Logic diagram

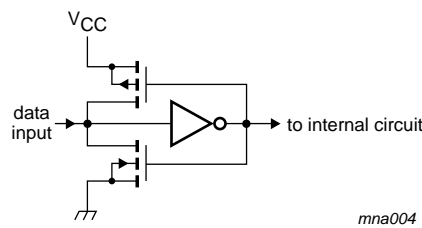


Fig 3. Bus hold circuit

## 5. Pinning information

### 5.1 Pinning

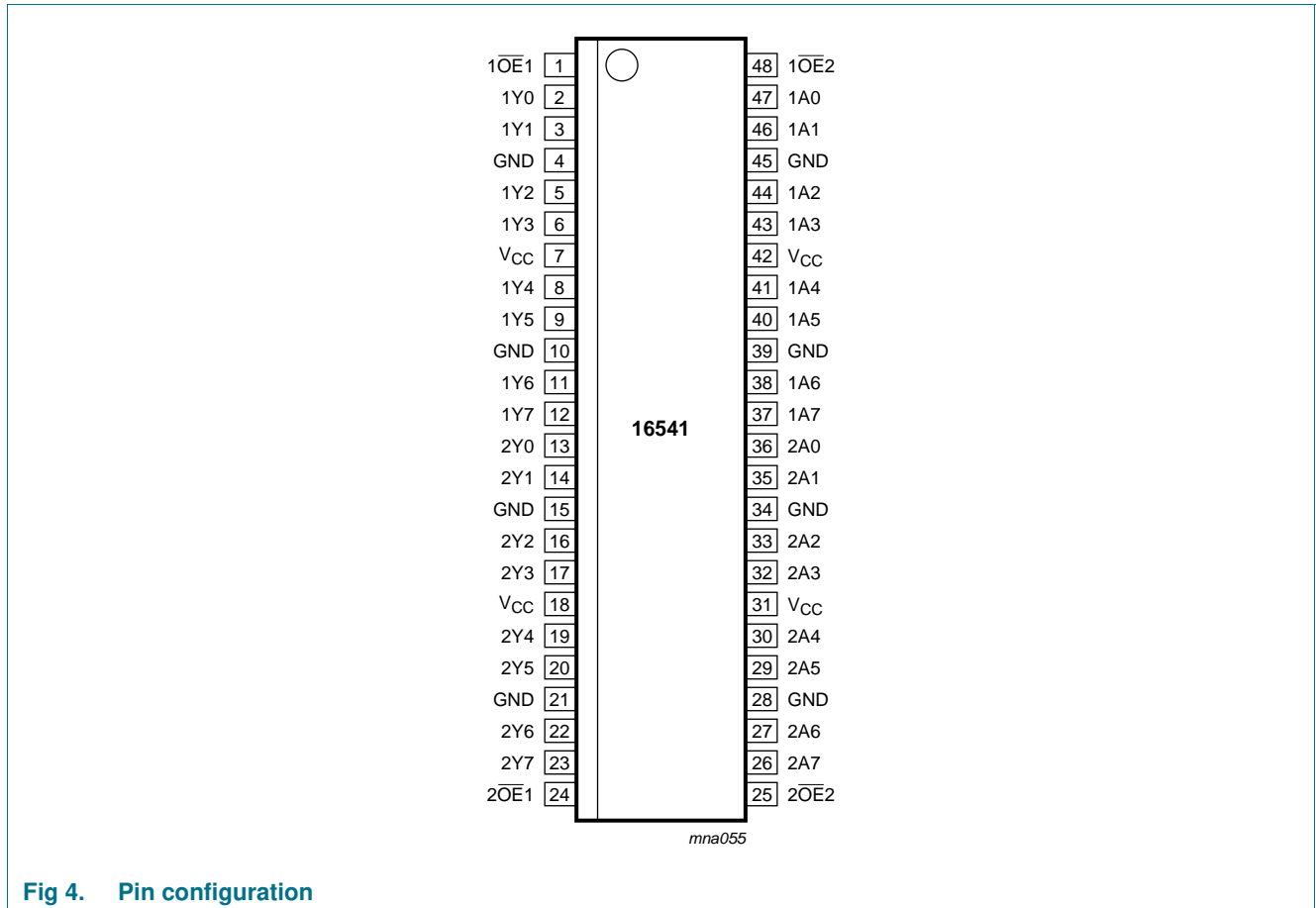


Fig 4. Pin configuration

### 5.2 Pin description

Table 2. Pin description

| Name            | Pin                            | Description                      |
|-----------------|--------------------------------|----------------------------------|
| 1OE1            | 1                              | output enable input (active LOW) |
| 1OE2            | 48                             | output enable input (active LOW) |
| 2OE1            | 24                             | output enable input (active LOW) |
| 2OE2            | 25                             | output enable input (active LOW) |
| GND             | 4, 10, 15, 21, 28, 34, 39, 45  | ground (0 V)                     |
| V <sub>CC</sub> | 7, 18, 31, 42                  | positive supply voltage          |
| 1Y[0:7]         | 2, 3, 5, 6, 8, 9, 11, 12       | data output                      |
| 2Y[0:7]         | 13, 14, 16, 17, 19, 20, 22, 23 | data output                      |
| 1A[0:7]         | 47, 46, 44, 43, 41, 40, 38, 37 | data input                       |
| 2A[0:7]         | 36, 35, 33, 32, 30, 29, 27, 26 | data input                       |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |      |     | Output |
|-------|------|-----|--------|
| nOE1  | nOE2 | nAn | nYn    |
| L     | L    | L   | L      |
| L     | L    | H   | H      |
| X     | H    | X   | Z      |
| H     | X    | X   | Z      |

- [1] H = HIGH voltage level  
 L = LOW voltage level  
 X = don't care  
 Z = high-impedance OFF-state

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min  | Max                   | Unit |
|------------------|-------------------------|--|------|-----------------------|------|
| V <sub>CC</sub>  | supply voltage          |  | -0.5 | +6.5                  | V    |
| V <sub>I</sub>   | input voltage           |  | -0.5 | +6.5                  | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0                                     | -50  | -                     | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 | -    | ±50                   | mA   |
| V <sub>O</sub>   | output voltage          | output HIGH or LOW state                               | -0.5 | V <sub>CC</sub> + 0.5 | V    |
|                  |                         | output 3-state   | -0.5 | +6.5                  | V    |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = 0 V to V <sub>CC</sub>                | -    | ±50                   | mA   |
| I <sub>CC</sub>  | supply current          |  | -    | 100                   | mA   |
| I <sub>GND</sub> | ground current          |  | -100 | -                     | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65  | +150                  | °C   |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C                   | -    | 500                   | mW   |

- [1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.  
 [2] The output voltage ratings may be exceeded if the output current ratings are observed.  
 [3] Above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating operations**

| Symbol           | Parameter                           | Conditions                              | Min  | Max             | Unit |
|------------------|-------------------------------------|---|------|-----------------|------|
| V <sub>CC</sub>  | supply voltage                      |   | 1.65 | 3.6             | V    |
|                  |                                     | functional                              | 1.2  | -               | V    |
| V <sub>I</sub>   | input voltage                       |   | 0    | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      | output HIGH or LOW state                | 0    | V <sub>CC</sub> | V    |
|                  |                                     | output 3-state or V <sub>CC</sub> = 0 V | 0    | 5.5             | V    |
| T <sub>amb</sub> | ambient temperature                 | in free air                             | -40  | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 1.65 V to 2.7 V       | 0    | 20              | ns/V |
|                  |                                     | V <sub>CC</sub> = 2.7 V to 3.6 V        | 0    | 10              | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | -40 °C to +85 °C       |                    |                        | -40 °C to +125 °C      |                        | Unit |
|-----------------|---------------------------|---|------------------------|--------------------|------------------------|------------------------|------------------------|------|
|                 |                           |   | Min                    | Typ <sup>[1]</sup> | Max                    | Min                    | Max                    |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V   | 1.08                   | -                  | -                      | 1.08                   | -                      | V    |
|                 |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                                    | 0.65 × V <sub>CC</sub> | -                  | -                      | 0.65 × V <sub>CC</sub> | -                      | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                      | 1.7                    | -                  | -                      | 1.7                    | -                      | V    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                      | 2.0                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V   | -                      | -                  | 0.12                   | -                      | 0.12                   | V    |
|                 |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                                    | -                      | -                  | 0.35 × V <sub>CC</sub> | -                      | 0.35 × V <sub>CC</sub> | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                      | -                      | -                  | 0.7                    | -                      | 0.7                    | V    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                      | -                      | -                  | 0.8                    | -                      | 0.8                    | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                   |                        |                    |                        |                        |                        |      |
|                 |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V           | V <sub>CC</sub> - 0.2  | V <sub>CC</sub>    | -                      | V <sub>CC</sub> - 0.3  | -                      | V    |
|                 |                           | I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V                      | 1.2                    | -                  | -                      | 1.05                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V                       | 1.8                    | -                  | -                      | 1.65                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V                      | 2.2                    | -                  | -                      | 2.05                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V                      | 2.4                    | -                  | -                      | 2.25                   | -                      | V    |
|                 |                           | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V                      | 2.2                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>OL</sub> | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                   |                        |                    |                        |                        |                        |      |
|                 |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V            | -                      | -                  | 0.2                    | -                      | 0.3                    | V    |
|                 |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                       | -                      | -                  | 0.45                   | -                      | 0.65                   | V    |
|                 |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                        | -                      | -                  | 0.6                    | -                      | 0.8                    | V    |
|                 |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                       | -                      | -                  | 0.4                    | -                      | 0.6                    | V    |
|                 |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                       | -                      | -                  | 0.55                   | -                      | 0.8                    | V    |
| I <sub>I</sub>  | input leakage current     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND <sup>[2]</sup> | -                      | ±0.1               | ±5                     | -                      | ±20                    | μA   |

**Table 6. Static characteristics ...continued**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol            | Parameter   | Conditions   | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |      | Unit |
|-------------------|---|--|------------------|--------------------|-----|-------------------|------|------|
|                   |   |  | Min              | Typ <sup>[1]</sup> | Max | Min               | Max  |      |
| I <sub>OZ</sub>   | OFF-state output current <sup>[2]</sup>           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>O</sub> = 5.5 V or GND     | -                | ±0.1               | ±5  | -                 | ±20  | µA   |
| I <sub>OFF</sub>  | power-off leakage supply                          | V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V  | -                | ±0.1               | ±10 | -                 | ±20  | µA   |
| I <sub>CC</sub>   | supply current                                    | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A                           | -                | 0.1                | 20  | -                 | 80   | µA   |
| ΔI <sub>CC</sub>  | additional supply current                         | per input pin; V <sub>CC</sub> = 1.65 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A | -                | 5                  | 500 | -                 | 5000 | µA   |
| C <sub>I</sub>    | input capacitance                                 | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>  | -                | 5.0                | -   | -                 | -    | pF   |
| I <sub>BHL</sub>  | bus hold LOW current <sup>[3][4]</sup>            | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 0.58 V  | 10               | -                  | -   | 10                | -    | µA   |
|                   |   | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 0.7 V  | 30               | -                  | -   | 25                | -    | µA   |
|                   |   | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 0.8 V  | 75               | -                  | -   | 60                | -    | µA   |
| I <sub>BHH</sub>  | bus hold HIGH current <sup>[3][4]</sup>           | V <sub>CC</sub> = 1.65; V <sub>I</sub> = 1.07 V  | -10              | -                  | -   | -10               | -    | µA   |
|                   |   | V <sub>CC</sub> = 2.3; V <sub>I</sub> = 1.7 V  | -30              | -                  | -   | -25               | -    | µA   |
|                   |   | V <sub>CC</sub> = 3.0; V <sub>I</sub> = 2.0 V  | -75              | -                  | -   | -60               | -    | µA   |
| I <sub>BHLO</sub> | bus hold LOW overdrive current <sup>[3][5]</sup>  | V <sub>CC</sub> = 1.95 V   | 200              | -                  | -   | 200               | -    | µA   |
|                   |   | V <sub>CC</sub> = 2.7 V  | 300              | -                  | -   | 300               | -    | µA   |
|                   |   | V <sub>CC</sub> = 3.6 V  | 500              | -                  | -   | 500               | -    | µA   |
| I <sub>BHHO</sub> | bus hold HIGH overdrive current <sup>[3][5]</sup> | V <sub>CC</sub> = 1.95 V   | -200             | -                  | -   | -200              | -    | µA   |
|                   |   | V <sub>CC</sub> = 2.7 V  | -300             | -                  | -   | -300              | -    | µA   |
|                   |   | V <sub>CC</sub> = 3.6 V  | -500             | -                  | -   | -500              | -    | µA   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

[2] The bus hold circuit is switched off when V<sub>I</sub> > V<sub>CC</sub> allowing 5.5 V on the input pin.

[3] For data inputs only; control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data inputs holds the input below the specified V<sub>I</sub> level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 7](#).

| Symbol             | Parameter                     | Conditions  | T <sub>amb</sub> = -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|--------------------|-------------------------------|---|-------------------------------------|--------------------|------|-------------------|------|------|
|                    |                               |   | Min                                 | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| t <sub>pd</sub>    | propagation delay             | nAn to nYn; see <a href="#">Figure 5</a> <sup>[2]</sup>                 | -                                   | 10                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                                   | 10                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                      | 1.8                                 | 4.7                | 10.4 | 1.8               | 12.0 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V  | 1.5                                 | 2.6                | 5.2  | 1.5               | 6.0  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.0                                 | 2.5                | 5.0  | 1.0               | 6.5  | ns   |
| t <sub>en</sub>    | enable time                   | n $\overline{O}E$ n to nYn; see <a href="#">Figure 6</a> <sup>[2]</sup> | -                                   | 17                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                                   | 17                 | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                      | 1.5                                 | 5.5                | 14.6 | 1.5               | 16.8 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V  | 1.0                                 | 3.2                | 7.7  | 1.0               | 8.9  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5                                 | 3.4                | 6.9  | 1.5               | 9.0  | ns   |
| t <sub>dis</sub>   | disable time                  | n $\overline{O}E$ n to nYn; see <a href="#">Figure 6</a> <sup>[2]</sup> | -                                   | 9.0                | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                                   | 9.0                | -    | -                 | -    | ns   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                      | 2.6                                 | 7.3                | 9.2  | 2.6               | 10.6 | ns   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V  | 1.0                                 | 4.1                | 5.2  | 1.0               | 6.0  | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5                                 | 4.6                | 6.5  | 1.5               | 8.5  | ns   |
| t <sub>sk(o)</sub> | output skew time              | V <sub>CC</sub> = 3.0 V to 3.6 V <sup>[3]</sup>                         | -                                   | -                  | 1.0  | -                 | 1.5  | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | -                                   | -                  | 1.0  | -                 | 1.5  | ns   |
| C <sub>PD</sub>    | power dissipation capacitance | per input; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[4]</sup>       | -                                   | 8.5                | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 1.65 V to 1.95 V                                      | -                                   | 8.5                | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 2.3 V to 2.7 V  | -                                   | 12.1               | -    | -                 | -    | pF   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V  | -                                   | 15.3               | -    | -                 | -    | pF   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

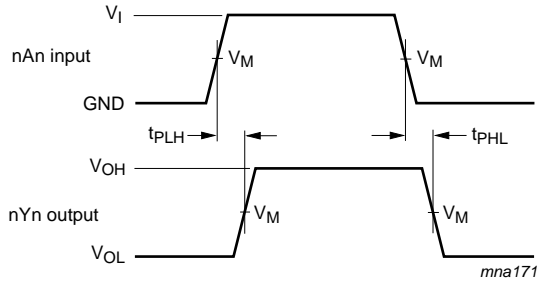
V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

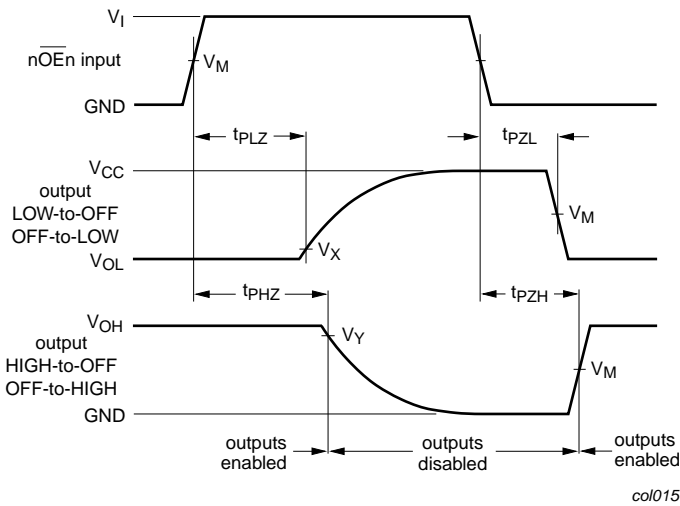


11. Waveforms



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 5. Input nAn to output nYn propagation delays**

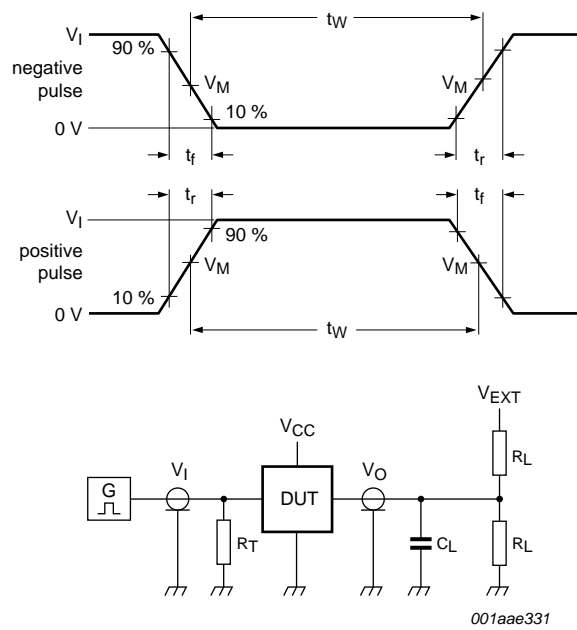


Measurement points are given in [Table 8](#).  
 Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 6. 3-state enable and disable times**

**Table 8. Measurement points**

| Supply voltage   | $V_M$               | Input    |                           |                           |
|------------------|---------------------|----------|---------------------------|---------------------------|
| $V_{CC}$         |                     | $V_I$    | $V_X$                     | $V_Y$                     |
| 1.2 V            | $0.5 \times V_{CC}$ | $V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.7 V            | 1.5 V               | 2.7 V    | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |
| 3.0 V to 3.6 V   | 1.5 V               | 2.7 V    | $V_{OL} + 0.3 \text{ V}$  | $V_{OH} - 0.3 \text{ V}$  |



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$V_{EXT}$  = External voltage for measuring switching times.

**Fig 7. Test circuit for measuring switching times**

**Table 9. Test data**

| Supply voltage   | Input    |               | Load  |              | $V_{EXT}$          |                    |                    |
|------------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
|                  | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        | $t_{PLH}, t_{PHL}$ | $t_{PLZ}, t_{PZL}$ | $t_{PHZ}, t_{PZH}$ |
| 1.2 V            | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 1.65 V to 1.95 V | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 1 k $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.3 V to 2.7 V   | $V_{CC}$ | $\leq 2$ ns   | 30 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 2.7 V            | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |
| 3.0 V to 3.6 V   | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ | open               | $2 \times V_{CC}$  | GND                |

12. Package outline

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1

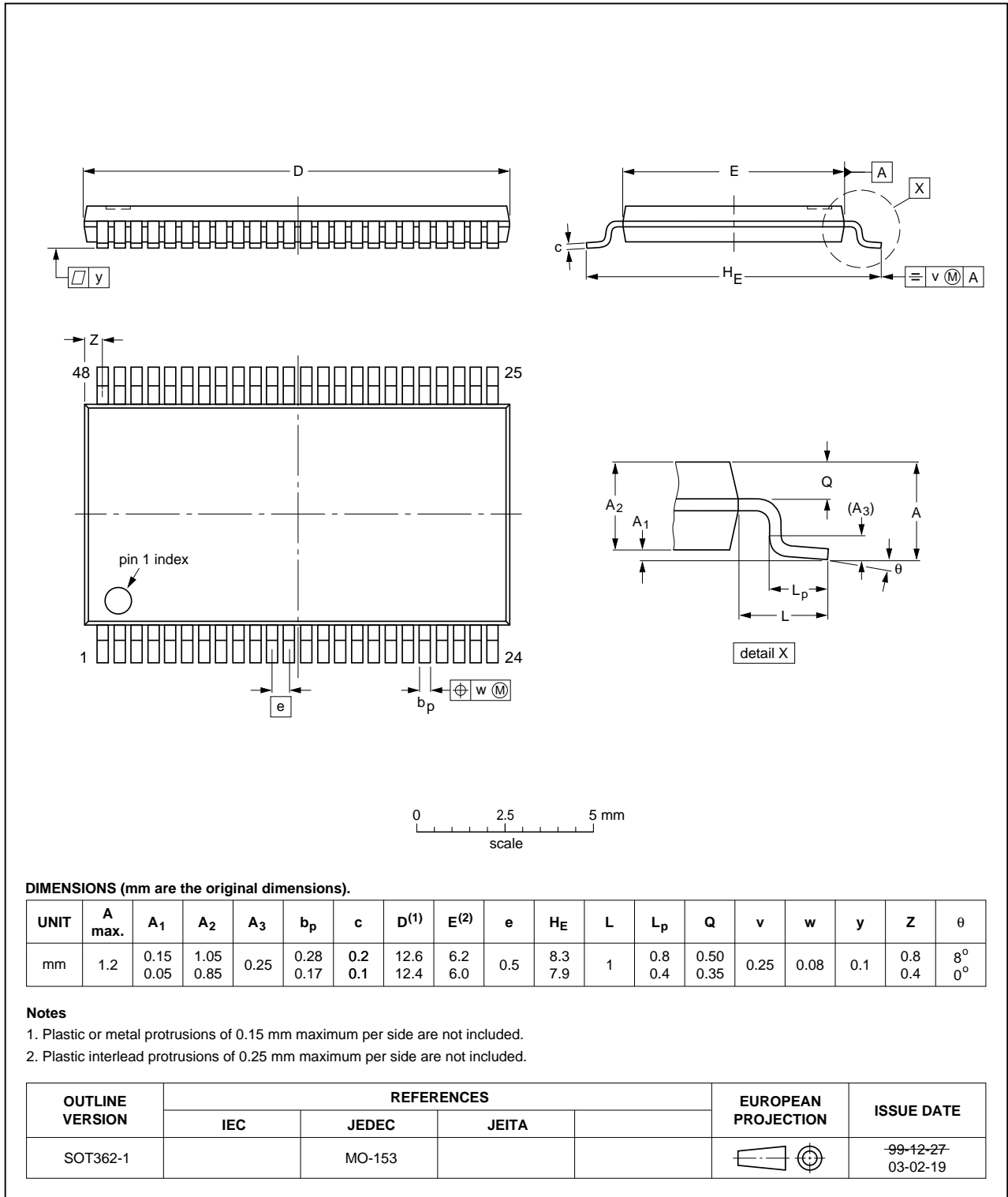


Fig 8. Package outline SOT362-1 (TSSOP48)

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1

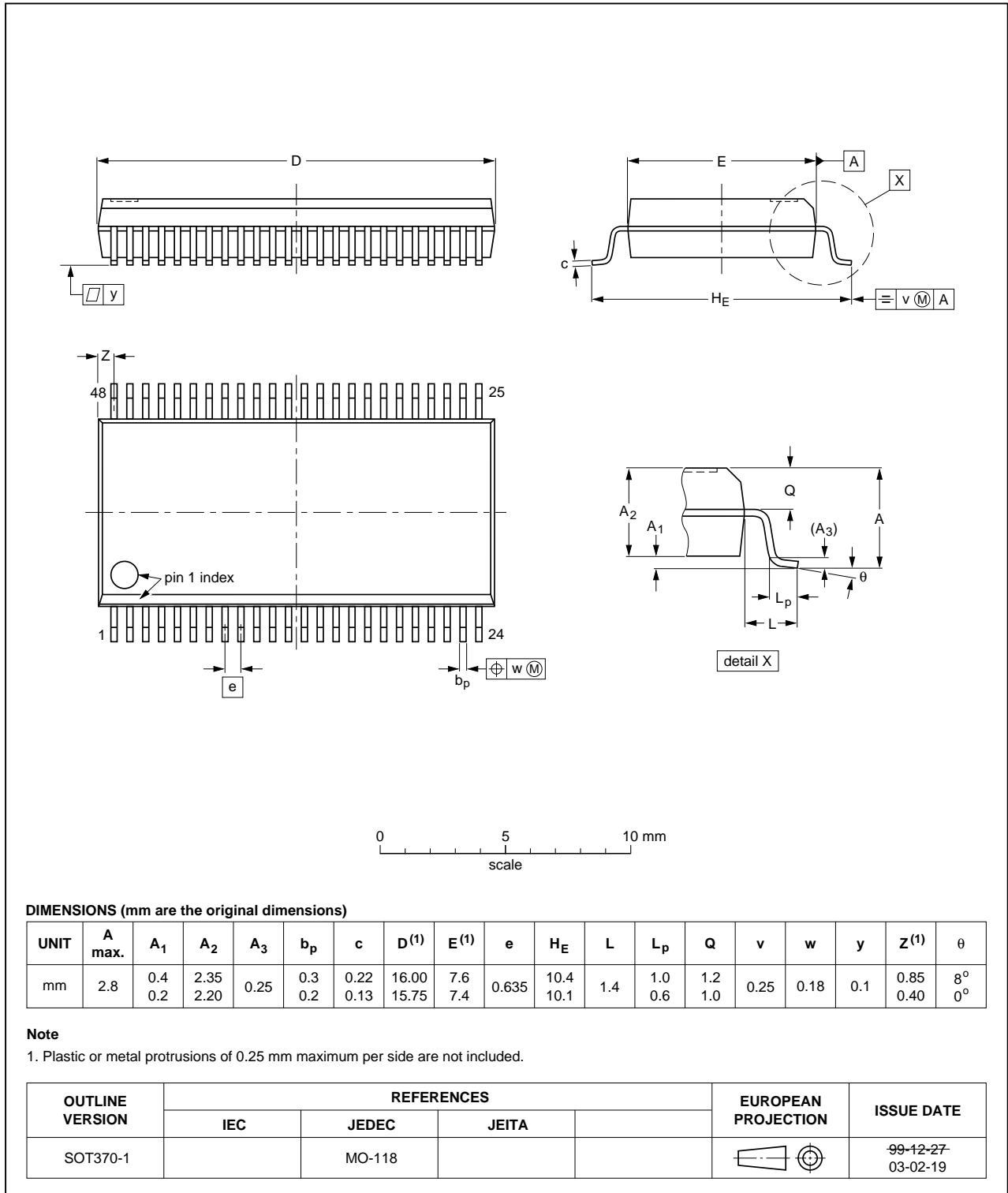


Fig 9. Package outline SOT370-1 (SSOP48)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| DUT     | Device Under Test           |
| ESD     | ElectroStatic Discharge     |
| HBM     | Human Body Model            |
| MM      | Machine Model               |
| TTL     | Transistor-Transistor Logic |

## 14. Revision history

Table 11. Revision history

| Document ID      | Release date   | Data sheet status     | Change notice | Supersedes       |
|------------------|--|-----------------------|---------------|------------------|
| 74LVCH16541A v.3 | 20120215   | Product data sheet    | -             | 74LVCH16541A v.2 |
| Modifications:   | <ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li><a href="#">Table 4</a>, <a href="#">Table 5</a>, <a href="#">Table 6</a>, <a href="#">Table 7</a>, and <a href="#">Table 9</a>: values added for lower voltage ranges.</li> </ul> |                       |               |                  |
| 74LVCH16541A v.2 | 20040218   | Product specification | -             | 74LVCH16541A v.1 |
| 74LVCH16541A v.1 | 19980519   | Product specification | -             | -                |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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